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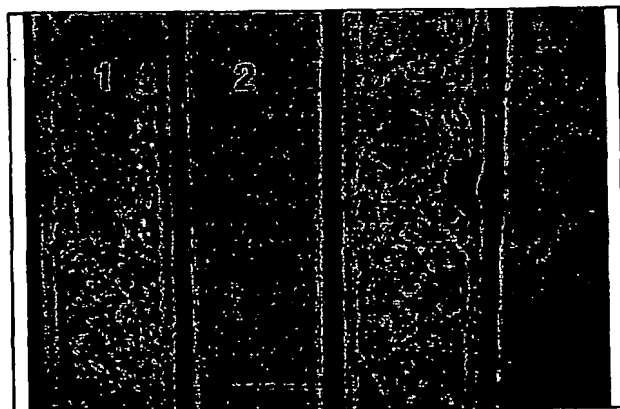
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(54) Title: PROTECTIVE LAYERS COMPATIBLE WITH THICK FILM PASTES



(57) Abstract: This invention relates to novel processes comprising a protective polymer layer in the fabrication of electronic devices using thick film pastes. The protective polymer layer is fabricated from materials which are insoluble after irradiation in the ester-type solvents contained in the thick film paste. By appropriate selection of protective film polymers, the protective film can be compatible with the thick film paste.

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